

Mechatronic Systems

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Modelling and Simulation with HDLs

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WILEY

First published under the title *Modellierung und Simulation mechatronischer Systeme — vom Chip zum Systementwurf mit Hardwarebeschreibungssprachen* © Hüthig-Verlag, Heidelberg, 2001
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Authorized translation from German language edition published by Hüthig-Verlag

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West Sussex PO19 8SQ, England

Telephone (+44) 1243 779777

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Wiley-VCH Verlag GmbH, Boschstr. 12, D-69469 Weinheim, Germany

John Wiley & Sons Australia Ltd, 33 Park Road, Milton, Queensland 4064, Australia

John Wiley & Sons (Asia) Pte Ltd, 2 Clementi Loop #02-01, Jin Xing Distripark, Singapore 129809

John Wiley & Sons Canada Ltd, 22 Worcester Road, Etobicoke, Ontario, Canada M9W 1L1

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Library of Congress Cataloging-in-Publication Data

Pelz, Georg, 1962-

[Modellierung und Simulation mechatronischer Systeme. English]

Mechatronic systems : modelling and simulation with HDLs / George Pelz.

p. cm.

Includes bibliographical references and index.

ISBN 0-470-84979-7 (alk. paper)

1. Mechatronics. 2. Computer hardware description languages. I. Title.

TJ163.12.P4513 2003

621—dc21

2002192433

British Library Cataloguing in Publication Data

A catalogue record for this book is available from the British Library

ISBN 0-470-84979-7

Typeset in 10.5/13pt Times by Laserwords Private Limited, Chennai, India

Printed and bound in Great Britain by Antony Rowe Ltd, Chippenham, Wiltshire

This book is printed on acid-free paper responsibly manufactured from sustainable forestry in which at least two trees are planted for each one used for paper production.

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Preface

Most of this work came into being during my employment at the Chair for Electron Devices and Circuits in the Electronics Engineering department of the Gerhard-Mercator University, Duisburg. Section 7.5 covers material that I have worked on for my current employer, Infineon Technologies.

At this point I would like to express my gratitude for the support that I received from many sides. My special thanks go to Prof. Dr. G. Zimmer, in whose department I was able to work continuously for many years on the subject of this book, and who helped me in many ways in the process. Moreover, I would like to thank Prof. Dr. M. Glesner for his support of the work.

I would also like to thank my colleagues at the Gerhard-Mercator University, Duisburg, the Fraunhofer Institut IMS and Infineon Technologies, who provided a great deal of assistance in the form of discussions and suggestions during the preparation of the book. The following in particular should be mentioned: Dr. J. Bielefeld, Dr. M. Leineweber, Dipl.-Ing. A. Lüdecke and Dipl.-Ing. L. Voßkämper.

Apart from the technical side, I would like to express my thanks to Tilmann Leopold. Last, but not least, I thank my family for their encouragement and support during the composition of this book.

Ebersberg, January 2003

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